



FQPF12N65C

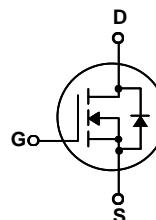
650V N-Channel MOSFET

● Features:

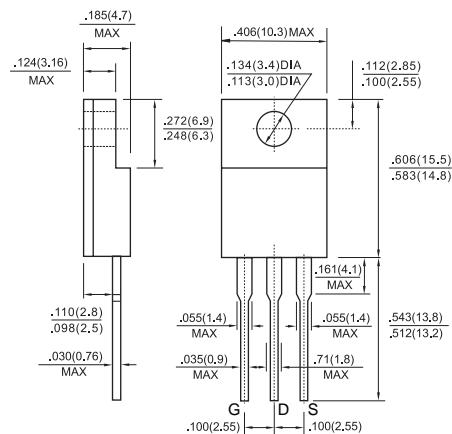
- 12.0A, 650V, $R_{DS(on)}(Typ) = 0.71\Omega$ @ $V_{GS} = 10V$
- Low Gate Charge
- Low C_{rss}
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability

● Application:

- High Frequency Switching Mode Power Supply
- Active Power Factor Correction



TO-220F



Dimensions in inches and (millimeters)

Absolute Maximum Ratings($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	650	V
I_D	Drain Current - Continuous($T_c=25^\circ C$)	12.0*	A
	- Continuous($T_c=100^\circ C$)	7.4*	A
I_{DM}	Drain Current -Pulsed (Note1)	48*	A
V_{GSS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy (Note2)	880	mJ
I_{AR}	Avalanche Current (Note1)	12.0	A
E_{AR}	Repetitive Avalanche Energy (Note1)	25	mJ
dv/dt	Peak Diode Recovery dv/dt (Note3)	4.5	V/ns
P_D	Power Dissipation($T_c = 25^\circ C$)	51	W
	-Derate above $25^\circ C$	0.41	W/ $^\circ C$
T_j	Operating Junction Temperature	150	$^\circ C$
T_{stg}	Storage Temperature Range	-55 to +150	$^\circ C$

* Drain Current Limited by Maximum Junction Temperature.

Thermal Characteristics

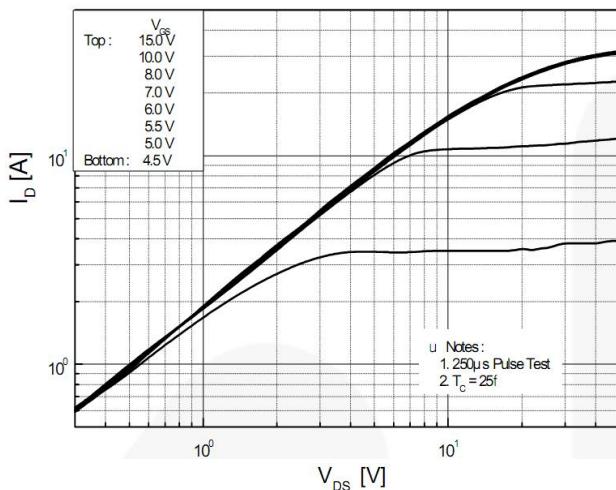
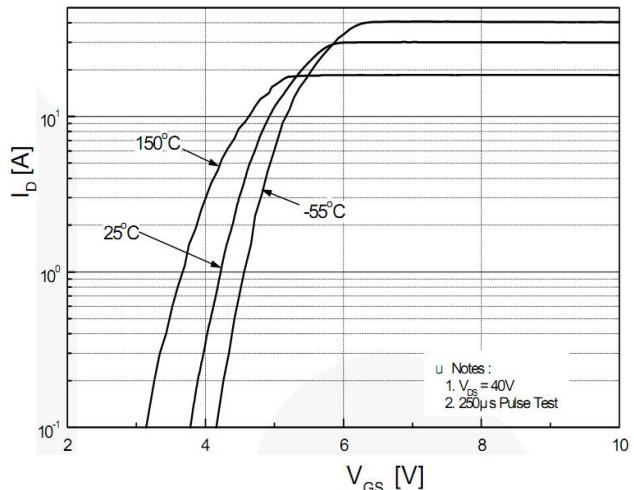
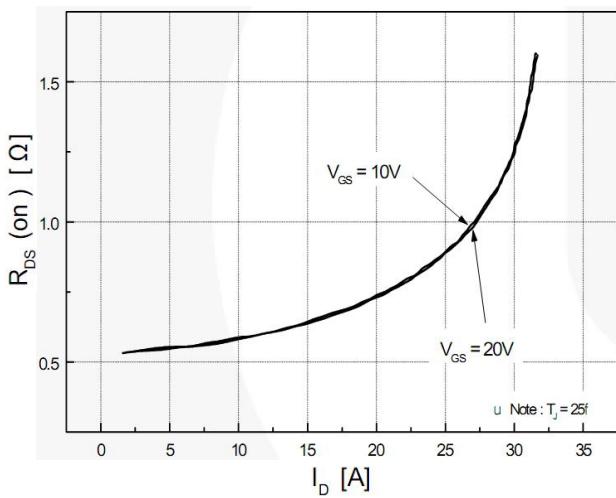
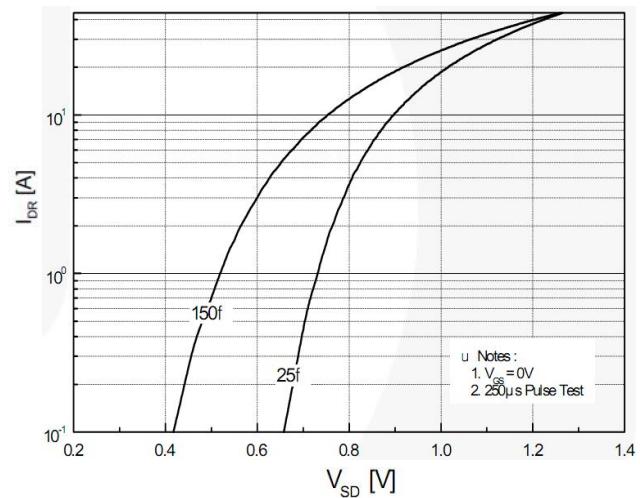
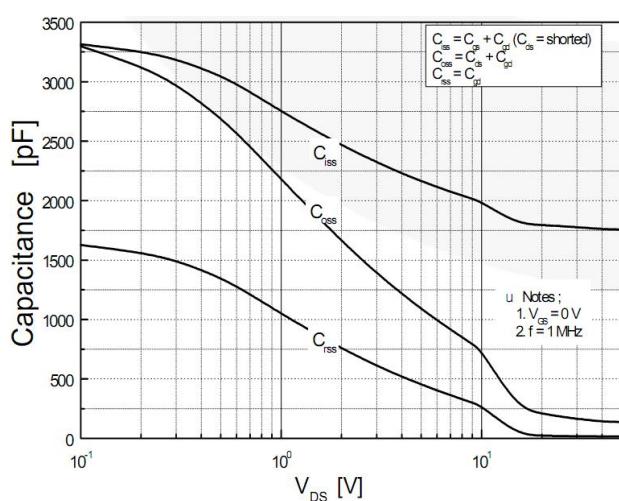
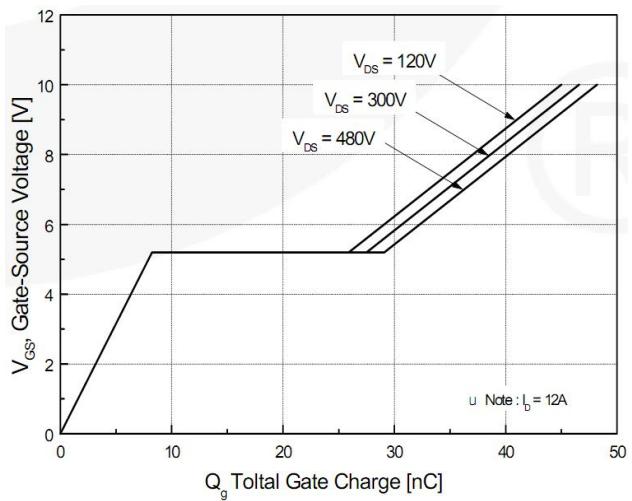
Symbol	Parameter	Max	Unit
R_{eJC}	Thermal Resistance,Junction to Case	2.45	$^\circ C/W$
R_{eJA}	Thermal Resistance,Junction to Ambient	62.5	$^\circ C/W$

Electrical Characteristics(Tc=25°C unless otherwise noted)

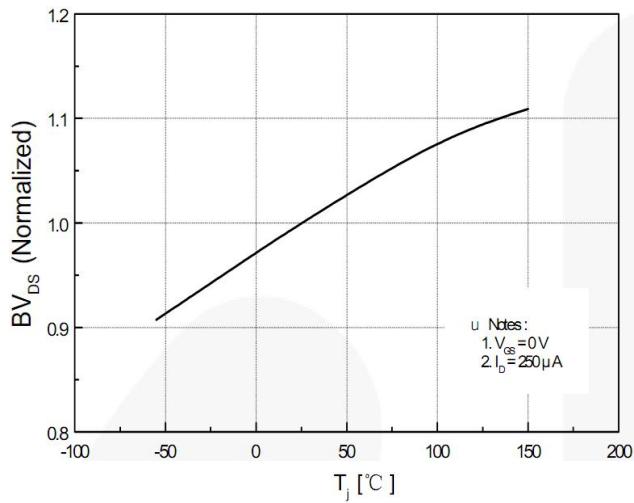
Symbol	Parameter	Test Conditons	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain-source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	650	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D=250\mu A$ (Referenced to 25°C)	--	0.7	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=650V, V_{GS}=0V$	--	--	1	μA
		$V_{DS}=520V, T_c=125^{\circ}C$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current,Forward	$V_{GS}=+30V, V_{DS}=0V$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current,Reverse	$V_{GS}=-30V, V_{DS}=0V$	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=6.0A$	--	0.71	0.85	Ω
g_{FS}	Forward Transconductance	$V_{DS}=40V, I_D=6.0A$ (Note4)	--	7.8	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$	--	1760	--	pF
C_{oss}	Output Capacitance		--	182	--	pF
C_{rss}	Reverse Transfer Capacitance		--	21	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 325V, I_D = 12A,$ $R_G = 25\Omega$ (Note4,5)	--	30	--	ns
t_r	Turn-On Rise Time		--	85	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	140	--	ns
t_f	Turn-Off Fall Time		--	90	--	ns
Q_g	Total Gate Charge	$V_{DS} = 520V, I_D = 12A,$ $V_{GS} = 10V$ (Note4,5)	--	48	--	nC
Q_{gs}	Gate-Source Charge		--	8.5	--	nC
Q_{gd}	Gate-Drain Charge		--	21	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Maximum Continuous Drain-Source Diode Forward Current	--	--	12	--	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	48	--	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_s = 12.0A$	--	--	1.3	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_s = 12.0A,$ $dI_F/dt = 100A/\mu s$ (Note4)	--	425	--	ns
Q_{rr}	Reverse Recovery Charge		--	4.31	--	μC

Notes:

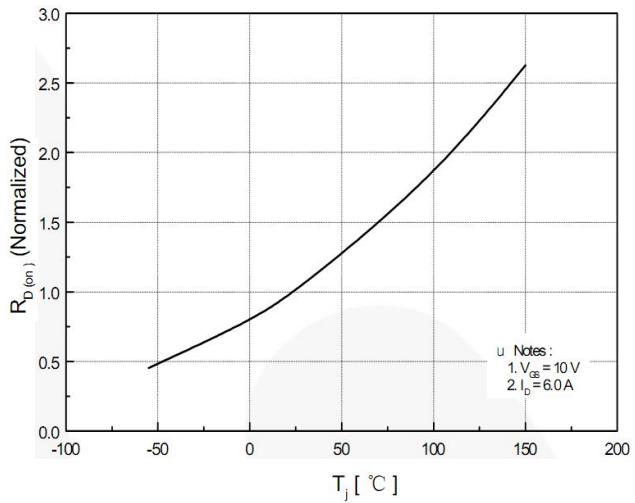
1. Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
2. $L = 11mH, I_{AS} = 12.0A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$.
3. $I_{SD} \leq 12.0A$, $di/dt \leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}C$.
4. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
5. Essentially Independent of Operating Temperature.

On-Region Characteristics**Transfer Characteristics****On-Resistance Variation vs. Drain Current and Gate Voltage****Body Diode Forward Voltage Variation vs. Source Current and Temperature****Capacitance Characteristics****Gate Charge Characteristics**

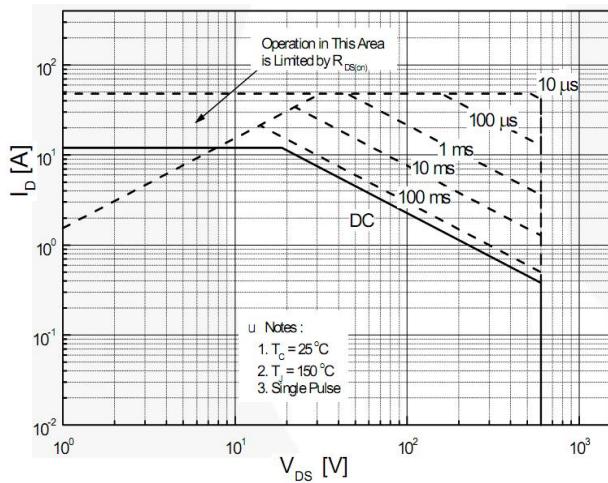
Breakdown Voltage Variation vs. Temperature



On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



Maximum Drain Current Vs. Case Temperature

